

28–40 GHz GaAs MMIC Low Noise Amplifier



AA038N1-00, AA038N2-00

Features

- Single Bias Supply Operation (4.5 V)
- 3.8 dB Typical Noise Figure at 38 GHz
- 17 dB Typical Small Signal Gain
- 0.25 μm Ti/Pd/Au Gates
- 100% On-Wafer RF, DC and Noise Figure Testing
- 100% Visual Inspection to MIL-STD-883 MT 2010

Description

Alpha's four-stage reactively-matched 28–40 GHz GaAs MMIC low noise amplifier has typical small signal gain of 17 dB with a typical noise figure of 3.8 dB at 38 GHz. The chip uses Alpha's proven 0.25 μm low noise PHEMT technology, and is based upon MBE layers and electron beam lithography for the highest uniformity and repeatability. The FETs employ surface passivation to ensure a rugged, reliable part with through-substrate via holes and gold-based backside metallization to facilitate a conductive epoxy die attach process.

Electrical Specifications at 25°C ($V_{DS} = 4.5\text{ V}$) AA038N1-00

Parameter	Condition	Symbol	Min.	Typ. ³	Max.	Unit
Drain Current		I_{DS}		35	50	mA
Small Signal Gain	$F = 28\text{--}40\text{ GHz}$	G	15	17		dB
Noise Figure	$F = 38\text{ GHz}$	NF		3.8	4.2	dB
Input Return Loss	$F = 28\text{--}40\text{ GHz}$	RL_I		-10	-6	dB
Output Return Loss	$F = 28\text{--}40\text{ GHz}$	RL_O		-8	-6	dB
Output Power at 1 dB Gain Compression ¹	$F = 38\text{ GHz}$	$P_1\text{ dB}$		6		dBm
Thermal Resistance ²		Θ_{JC}		101		°C/W

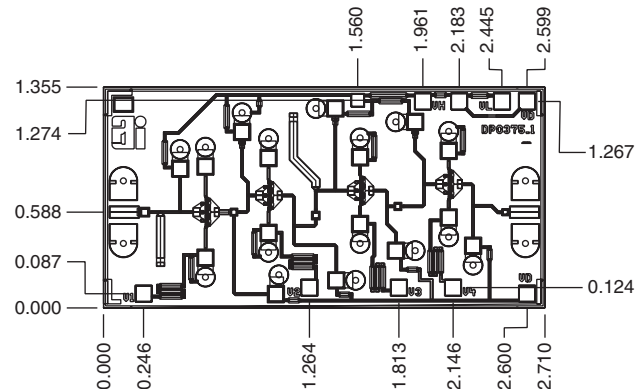
AA038N2-00

Parameter	Condition	Symbol	Min.	Typ. ³	Max.	Unit
Drain Current		I_{DS}		35	50	mA
Small Signal Gain	$F = 37\text{--}39.5\text{ GHz}$	G	17	19		dB
Noise Figure	$F = 38\text{ GHz}$	NF		3.8	4.2	dB
Input Return Loss	$F = 37\text{--}39.5\text{ GHz}$	RL_I		-14	-6	dB
Output Return Loss	$F = 37\text{--}39.5\text{ GHz}$	RL_O		-11	-8	dB
Output Power at 1 dB Gain Compression ¹	$F = 38\text{ GHz}$	$P_1\text{ dB}$		6		dBm
Thermal Resistance ²		Θ_{JC}		101		°C/W

1. Not measured on a 100% basis.

2. Calculated value based on measurement of discrete FET.

Chip Outline



Dimensions indicated in mm.

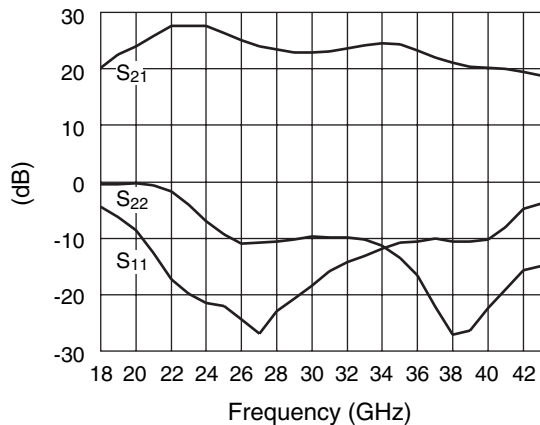
All DC (V) pads are 0.1 x 0.1 mm and RF In, Out pads are 0.07 mm wide.

Chip thickness = 0.1 mm.

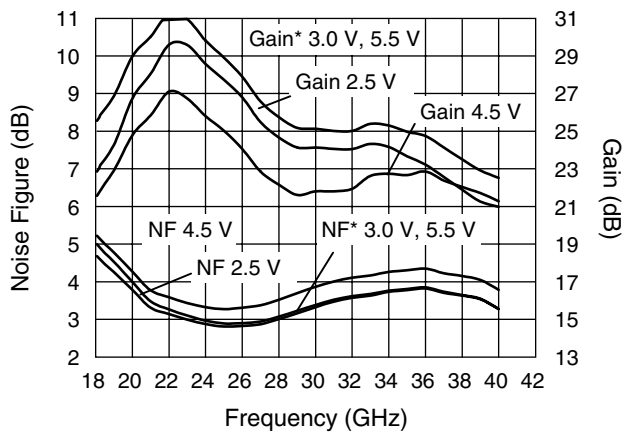
Absolute Maximum Ratings

Characteristic	Value
Operating Temperature (T_C)	-55°C to +90°C
Storage Temperature (T_{ST})	-65°C to +150°C
Bias Voltage (V_D)	6 V _{DC}
Power In (P_{IN})	10 dBm
Junction Temperature (T_J)	175°C

Typical Performance Data

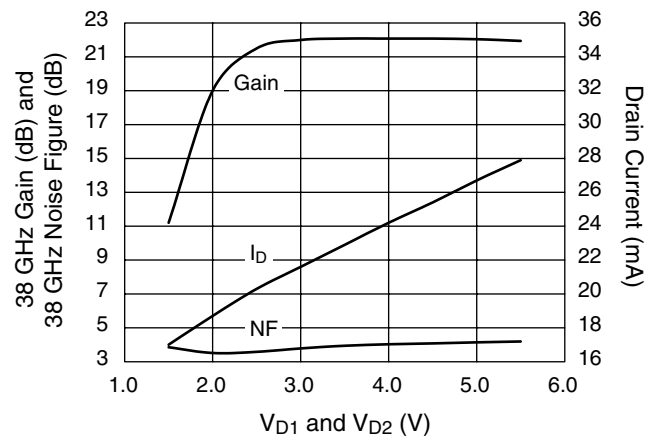


Typical Small Signal Performance S-Parameters ($V_D = 4.5\text{ V}$)



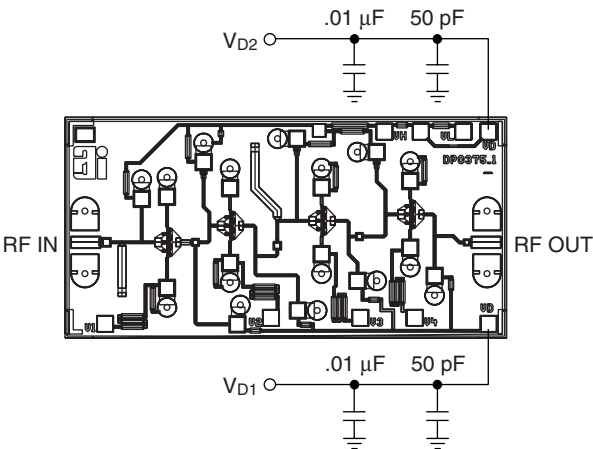
Typical Gain and Noise Figure Performance for Three Bias Conditions

*Special Bias: $V_{D1} = 3.0\text{ V}$, $V_{D2} = 5.5\text{ V}$



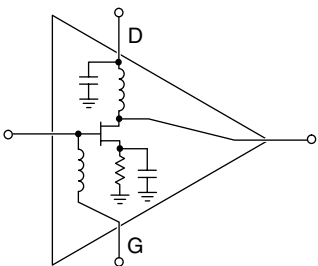
Typical Gain and Noise Figure Performance vs. Drain Bias ($V_{D1} = V_{D2}$)

Bias Arrangement



For biasing on, adjust V_D from zero to the desired value (4.5 V recommended). For biasing off, reverse the biasing on procedure.

Circuit Schematic



Detail A

